



Declaration for U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

COMPOSITION FOR COATING HAVING A GAS BARRIER PROPERTY, COATING AND COATED FILM HAVING A GAS BARRIER PROPERTY USED THE SAME

the specification of which is attached hereto unless the following is checked



was filed on December 17, 2001 as United States Application Number 10/015,564 and was amended on (if applicable).

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I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application for which priority is claimed:

(List prior foreign applications. See note A on back of this page)	<u>2000-394205</u> (Number)	<u>Japan</u> (Country)	<u>26/December/2000</u> (Day/Month/Year Filed)	Priority Claimed <u>XX</u> Yes ___ No
	<u>2001-104280</u> (Number)	<u>Japan</u> (Country)	<u>3/April/2001</u> (Day/Month/Year Filed)	<u>XX</u> Yes ___ No
	<u>2001-104281</u> (Number)	<u>Japan</u> (Country)	<u>3/April/2001</u> (Day/Month/Year Filed)	<u>XX</u> Yes ___ No
	_____ (Number)	_____ (Country)	_____ (Day/Month/Year Filed)	___ Yes ___ No

(See note B on back of this page)

___ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

(List Prior U.S. Applications)	(Appln. Serial No.)	(Filing Date)	(Status: Patented, Pending, Abandoned)
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I hereby claim priority benefits under Title 35, United States Code, § 119 (e) of any provisional application(s) for patent listed below:

(List prior provisional applications.)	(Serial Number)	(Day/Month/Year Filed)
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I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



23850

PATENT TRADEMARK OFFICE

Please direct all communications to the following address:



23850

PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor **Takaaki KUTSUNA**

Inventor's signature	<u>Takaaki Kutsuna</u>	Date	<u>5 / March / 2002</u>
Residence	<u>Hiratsuka-shi, Japan</u>	Citizenship	<u>Japan</u>
Post Office Address	<u>c/o Mitsubishi Gas Chemical Co. Inc., Hiratsuka Research Laboratory,</u> <u>6-2, Higashiyawata 5-chome, Hiratsuka-shi, Kanagawa Japan</u>		

Full name of second inventor (given name, family name) **Shuta KIHARA**

Inventor's signature	<u>Shuta Kihara</u>	Date	<u>6 / March / 2002</u>
Residence	<u>Hiratsuka-shi, Japan</u>	Citizenship	<u>Japan</u>
Post Office Address	<u>c/o Mitsubishi Gas Chemical Co. Inc., Hiratsuka-shi Research Laboratory</u> <u>6-2, Higashiyawata 5-chome, Hiratsuka-shi, Kanagawa, Japan</u>		

Declaration For U.S. Patent Application

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I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

(Insert Title) COMPOSITION FOR COATING HAVING A GAS BARRIER PROPERTY, COATING
AND COATED FILM HAVING A GAS BARRIER PROPERTY USED THE SAME

the specification of which is attached hereto unless the following is checked:



was filed on _____ as United States Application Number or PCT International
Application Number _____ and was amended on _____
(if applicable).

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(List prior foreign applications. See note A on back of this page)	2000-394205 (Number)	Japan (Country)	December 26, 2000 (Day/Month/Year Filed)	Priority Claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	2001-104280 (Number)	Japan (Country)	April 3, 2001 (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	2001-104281 (Number)	Japan (Country)	April 3, 2001 (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	(Number)	(Country)	(Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No

(See note B on back of this page)

☐ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

_____ (Application Number)	_____ (Filing Date)
_____ (Application Number)	_____ (Filing Date)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of the application:

(List Prior U.S. Applications)	_____ (Application Serial Number)	_____ (Filing Date)	_____ (Status) (patented, pending, abandoned)
	_____ (Application Serial Number)	_____ (Filing Date)	_____ (Status) (patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name) Takaaki Kutsuna

(See note
C above)

Inventor's Signature Takaaki Kutsuna Date December 5, 2001

Residence Hiratsuka-shi ~~Hiratsuka-shi~~ Citizenship Japan

Post Office Address c/o Mitsubishi Gas Chemical Co. Inc., Hiratsuka
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Full name of second inventor (given name, family name) Shuta Kihara

Inventor's Signature Shuta Kihara Date December 5, 2001

Residence Hiratsuka-shi ~~Hiratsuka-shi~~ Citizenship Japan

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Full name of third inventor (given name, family name) Tadashi

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of fourth inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of fifth inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of sixth inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of seventh inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____

Full name of eighth inventor (given name, family name) _____

Inventor's Signature _____ Date _____

Residence _____ Citizenship _____

Post Office Address _____